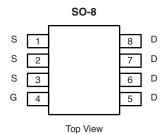


N-Channel 80 V (D-S) Super Trench Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	80			
$R_{DS(on)}(\Omega)$ at $V_{GS} = 10 \text{ V}$	0.006			
$R_{DS(on)}(\Omega)$ at $V_{GS} = 6 \text{ V}$	0.0075			
I _D (A)	16			
Configuration	Single			



FEATURES

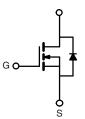
- Super Trench technology Power MOSFET
- Excellent gate charge x Rds (on) product(FOM)
- Very low on-resfistance Rds (on)
- \bullet 100 % R_g and UIS Tested

RoHS COMPLIANT HALOGEN

FREE

APPLICATIONS

- DC/DC Converter
- Ideal for hfigh-frequency swfitchfing and synchronous



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V_{DS}	80	V	
Gate-Source Voltage		V _{GS}	± 20	V	
Continuous Drain Current	T _C = 25 °C	1	16		
	T _C = 125 °C	- I _D	9		
Continuous Source Current (Diode Conduction)		I _S	6	А	
Pulsed Drain Current ^a		I _{DM}	67		
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	50		
Single Pulse Avalanche Energy		E _{AS}	125	mJ	
Maximum Power Dissipation ^a	T _C = 25 °C	P _D	7.1	· W	
	T _C = 125 °C	r _D	2.3		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to + 175	°C	

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	LIMIT	UNIT		
Junction-to-Ambient PC	CB Mount ^b	R _{thJA}	80	°C/W		
Junction-to-Foot (Drain)		R _{thJF}	21	- C/W		

Notes

- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- b. When mounted on 1" square PCB (FR-4 material).
- c. Parametric verification ongoing.

服务热线:400-655-8788

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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static	1			ı			ı
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0$, $I_D = 250 \mu A$		80	-	-	
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	$V_{DS} = V_{GS}, I_D = 250 \mu A$		3.0	3.5	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA
		V _{GS} = 0 V	V _{DS} = 60 V	-	-	1.0	μΑ
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V	V _{DS} = 80 V, T _J = 125 °C	-	-	50	
		V _{GS} = 0 V	V _{DS} = 80 V, T _J = 175 °C	-	-	250	
On-State Drain Current ^a	I _{D(on)}	V _{GS} = 10 V	$V_{DS} \ge 5 V$	30	-	-	Α
		V _{GS} = 10 V	I _D = 6 A	-	0.0048	-	Ω
Dualis Carrier On Chata Basistanas		V _{GS} = 10 V	I _D = 6 A, T _J = 125 °C	_	0.011		
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 10 V	I _D = 6 A, T _J = 175 °C	_	0.015	-	
		V _{GS} = 6 V	I _D = 5 A	-	0.006	-	
Forward Transconductance ^b	9 _{fs}	V _{DS} = 15 V, I _D = 6 A		-	25	-	S
Dynamic ^b							
Input Capacitance	C _{iss}		V _{GS} = 0 V V _{DS} = 25 V, f = 1 MHz	-	2531	3165	pF
Output Capacitance	C _{oss}	$V_{GS} = 0 V$		-	382	480	
Reverse Transfer Capacitance	C _{rss}	1		-	153	195	
Total Gate Charge ^c	Qg			-	45	68	
Gate-Source Charge ^c	Q _{gs}	V _{GS} = 10 V	$V_{DS} = 30 \text{ V}, I_{D} = 12 \text{ A}$	-	9.9	-	nC
Gate-Drain Charge ^c	Q _{gd}	1		-	11.2	-	
Gate Resistance	R_g	f = 1 MHz		0.40	0.87	1.30	Ω
Turn-On Delay Time ^c	t _{d(on)}	$V_{DD} = 30 \text{ V, } R_L = 2.5 \Omega$ $I_D \cong 12 \text{ A, } V_{GEN} = 10 \text{ V, } R_g = 1 \Omega$		-	13	20	
Rise Time ^c	t _r			-	12	18	- ns
Turn-Off Delay Time ^c	t _{d(off)}			-	25	38	
Fall Time ^c	t _f			-	9	14	
Source-Drain Diode Ratings and Chara	acteristics ^b						<u> </u>
Pulsed Current ^a	I _{SM}			-	-	67	Α
Forward Voltage	V _{SD}	I _F = 1.7 A, V _{GS} = 0		-	0.72	1.2	V

Notes

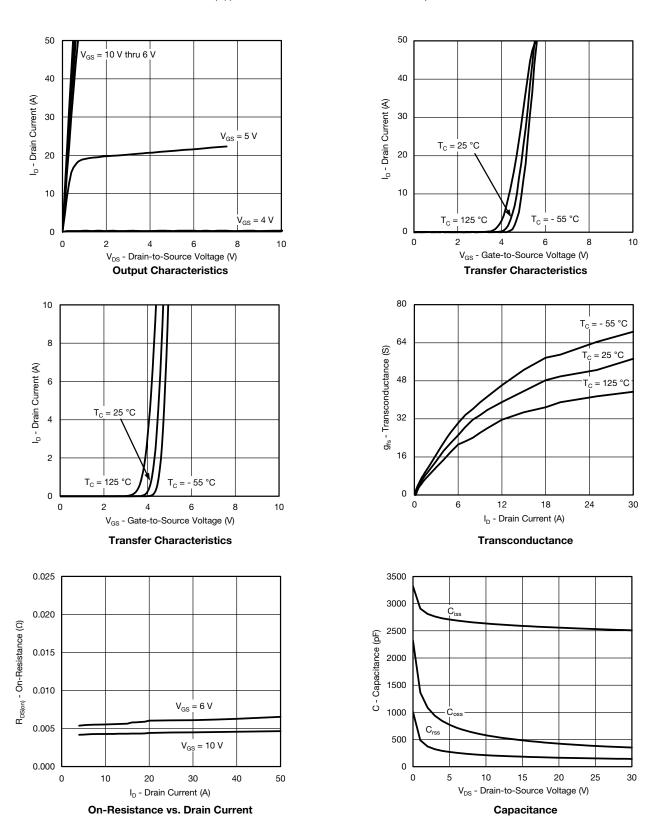
2

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

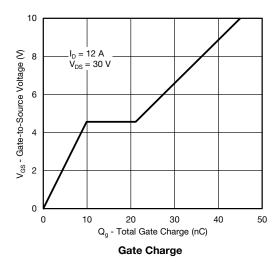


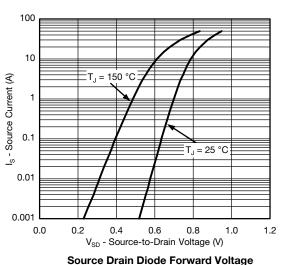
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)

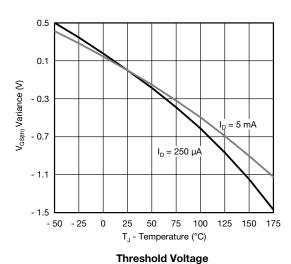


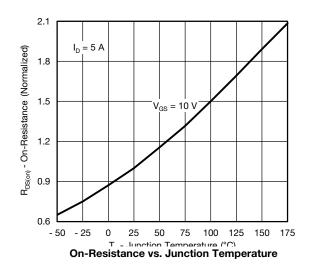


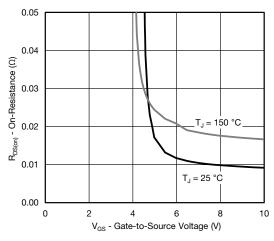
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



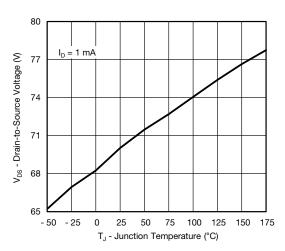








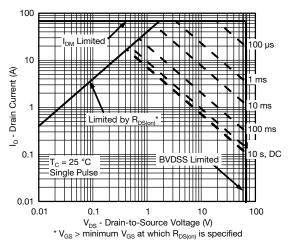
On-Resistance vs. Gate-to-Source Voltage



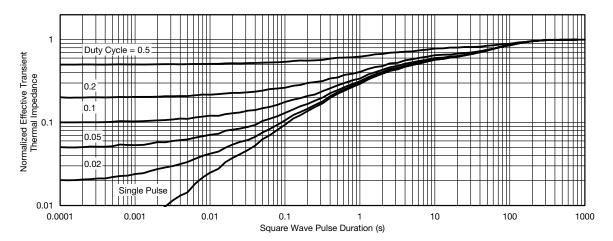
Drain Source Breakdown vs. Junction Temperature



THERMAL RATINGS ($T_A = 25$ °C, unless otherwise noted)



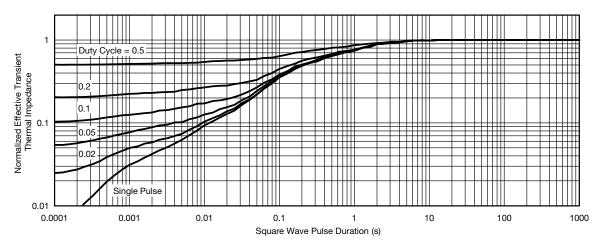
Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient



THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Foot

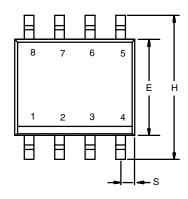
Note

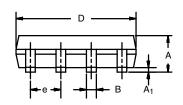
- The characteristics shown in the two graphs
- Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
- Normalized Transient Thermal Impedance Junction-to-Foot (25 °C)

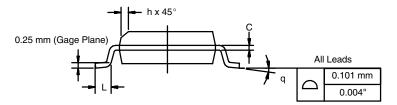
are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.



SOIC (NARROW): 8-LEADJEDEC Part Number: MS-012







	MILLIMETERS		METERS INCHES		
DIM	Min	Max	Min	Max	
Α	1.35	1.75	0.053	0.069	
A ₁	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
Е	3.80	4.00	0.150	0.157	
е	1.27	BSC	0.050 BSC		
Н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
FONL C 00507 Part L 11 Car 00					

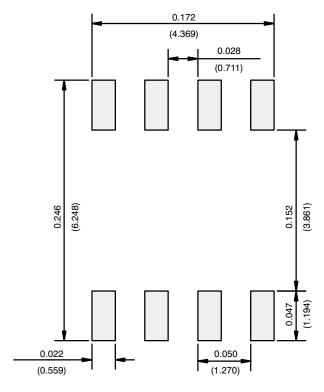
ECN: C-06527-Rev. I, 11-Sep-06

DWG: 5498

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RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)



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DMN2080UCB4-7 DMN61D9UWQ-13 US6M2GTR DMN31D5UDJ-7 DMP22D4UFO-7B DMN1006UCA6-7 DMN16M9UCA6-7
STF5N65M6 IRF40H233XTMA1 STU5N65M6 DMN6022SSD-13 DMN13M9UCA6-7 DMTH10H4M6SPS-13 DMN2990UFB-7B
IPB80P04P405ATMA2 2N7002W-G MCAC30N06Y-TP MCQ7328-TP BXP7N65D BXP4N65F AOL1454G WMJ80N60C4 BXP2N20L
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